

April 2013

FGA20N120FTD 1200 V, 20 A Field Stop Trench IGBT

Features

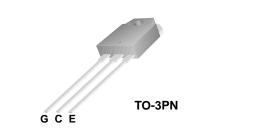
- Field Stop Trench Technology
- High Speed Switching
- Low Saturation Voltage: V_{CE(sat)} = 1.6 V @ I_C = 20 A
- High Input Impedance
- RoHS Compliant

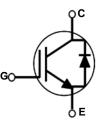
Applications

• Induction heating, Microvewave oven

General Description

Using advanced field stop trench technology, Fairchild[®]'s 1200V trench IGBTs offer superior conduction and switching performances for soft switching applications. The device can operate in parallel configuration with exceptional avalanche ruggedness. This device is designed for induction heating and microwave oven.





Absolute Maximum Ratings

Symbol	Description		Ratings	Unit	
V _{CES}	Collector to Emitter Voltage		1200	V	
V _{GES}	Gate to Emitter Voltage		± 25	V	
I _C	Continuous Collector Current	@ T _C = 25 ^o C	40	A	
	Continuous Collector Current	@ T _C = 100°C	20	A	
I _{CM (1)}	Pulsed Collector Current		60	А	
I _F	Diode Continuous Forward Current	@ T _C = 25 ^o C	20	А	
P _D	Maximum Power Dissipation	@ T _C = 25 ^o C	298	W	
• D	Maximum Power Dissipation	@ T _C = 100°C	119	W	
TJ	Operating Junction Temperature		-55 to +150	°C	
T _{stg}	Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Notes:

1: Repetitive rating, Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	-	0.42	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	2.0	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W

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		Package	ackage Reel Size		Width	Quantity 30		
		TO-3PN	-	-				
Electric	al Cha	racteristics of t	he IGBT T _{c=2}	5°C unless otherwise noted				
Symbol		Parameter	Test	Conditions	Min.	Тур.	Max.	Unit
Off Charac	toristics							
BV _{CES}		to Emitter Breakdown V	oltage V _{GE} = 0V, I _C	s = 1mA	1200	_	_	V
		Cut-Off Current	$V_{CE} = V_{CES}$		-	_	1	mA
I _{CES}		age Current				-	±250	nA
GES	O L LOUN		VGE - VGES	$V_{GE} = V_{GES}, V_{CE} = 0V$			±20U	ΠA
On Charac	teristics							
$V_{GE(th)}$	G-E Thre	shold Voltage	I _C = 20mA, '	$V_{CE} = V_{GE}$	3.5	5.9	7.5	V
		to Emitter Saturation Vo		$I_{C} = 20A, V_{GE} = 15V$ $T_{C} = 25^{\circ}C$		1.59	2	V
			I _C = 20A, V _G T _C = 125°C	$I_{C} = 20A, V_{GE} = 15V,$ $T_{C} = 125^{\circ}C$		1.85	-	V
Dynamic C	haracteris	stics						
C _{ies}	Input Cap	bacitance			-	3080	-	pF
C _{oes}	Output C	apacitance	$V_{CE} = 30V, V_{GE} = 0V,$		-	95	-	pF
C _{res}	Reverse	e Transfer Capacitance f = 1MHz			-	60	-	pF
	Character	iatiaa				1		
Switching (Delay Time			-	30	_	ns
t _r	Rise Time				-	79	-	ns
t _{d(off)}		Delay Time	V _{CC} = 600V	la – 20A	-	143	-	ns
t _f	Fall Time		R _G = 10Ω, \	/ _{GE} = 15V,	_	217	320	ns
E _{on}	Turn-On	Switching Loss	Resistive Lo	bad, $T_C = 25^{\circ}C$	-	0.42	-	mJ
E _{off}		Switching Loss			-	0.71	1.05	mJ
E _{ts}		tching Loss			-	1.13	-	mJ
t _{d(on)}		Delay Time			-	29	-	ns
t _r	Rise Time				-	93	-	ns
t _{d(off)}	Turn-Off	Delay Time	$V_{CC} = 600V$. lc = 20A.	-	147	-	ns
t _f	Fall Time	-	$V_{CC} = 600$ V, $I_C = 20$ A, $R_G = 10\Omega$, $V_{GE} = 15$ V,		-	259	-	ns
E _{on}	Turn-On	Switching Loss	Resistive Lo	oad, T _C = 125°C	-	0.47	-	mJ
E _{off}	Turn-Off	Switching Loss			-	0.86	-	mJ
E _{ts}	Total Swit	tching Loss			-	1.33	-	mJ
Q _g	Total Gate	e Charge			-	137	-	nC
Q _{ge}	Gate to E	mitter Charge	$V_{CE} = 600V$, I _C = 20A,	-	23	-	nC
Q _{gc}	Gate to C	Collector Charge	V _{GE} = 15V		-	65	-	nC

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Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Unit
V _{FM}	Diode Forward Voltage	I _F = 20A	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	1.3	1.7	V
* FIVI	Diode i orward voltage	1F - 207	$T_{\rm C} = 125^{\rm o}{\rm C}$	-	1.3	-	, v
		$T_{\rm C} = 25^{\rm o}{\rm C}$	-	447	-	ns	
t _{rr}		I _{ES} =20A,	$T_{\rm C} = 125^{\rm o}{\rm C}$	-	485	-	110
	Diode Peak Reverse Recovery Current	dl/dt = 200A/μs	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	48	-	А
Irr			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	50	-	
Q _{rr}	Diode Reverse Recovery Charge		$T_{\rm C} = 25^{\rm o}{\rm C}$	-	10.8	-	μC
œrr	Didde Revelse Receivery charge		$T_{C} = 125^{\circ}C$	-	12	-	μΟ

Electrical Characteristics of the Diode $T_c = 25^{\circ}C$ unless otherwise noted

Typical Performance Characteristics



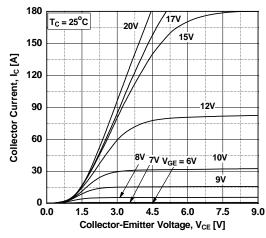


Figure 3. Typical Saturation Voltage Characteristics

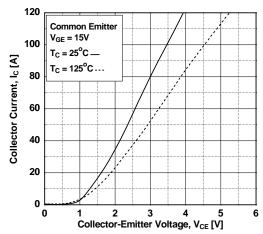


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

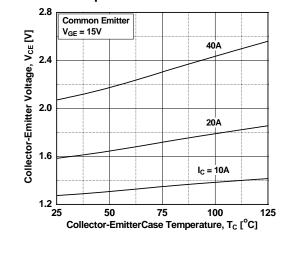


Figure 2. Typical Output Characteristics

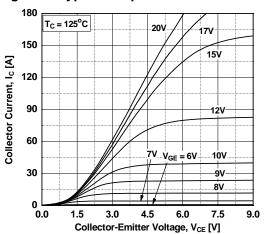
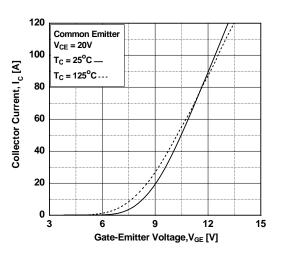
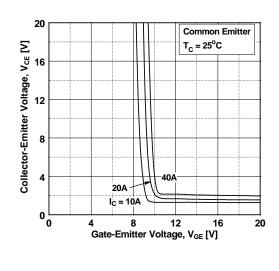


Figure 4. Transfer Characteristics







Typical Performance Characteristics Figure 7. Saturation Voltage vs. V_{GE} 20 Common Emitter $T_C = 125^{\circ}C$ 20A 40A $I_{\rm C} = 10A$ 0 0 4 8 12 16 20 Gate-Emitter Voltage, V_{GE} [V] Figure 9. Gate charge Characteristics 15 Common Emitter $T_C = 25^{\circ}C$ Gate-Emitter Voltage, V_{GE} [V] 8 0 6 71 V_____ = 200V 600V 400V

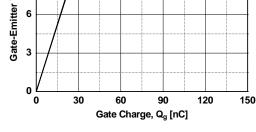


Figure 11. Turn-on Characteristics vs. Gate Resistance

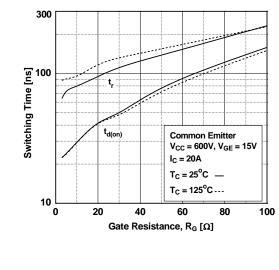


Figure 8. Capacitance Characteristics

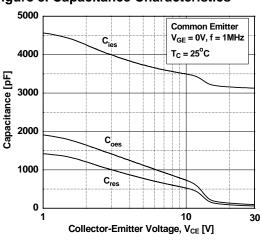
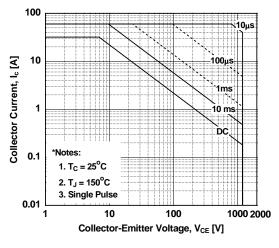
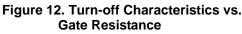
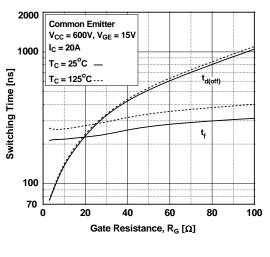


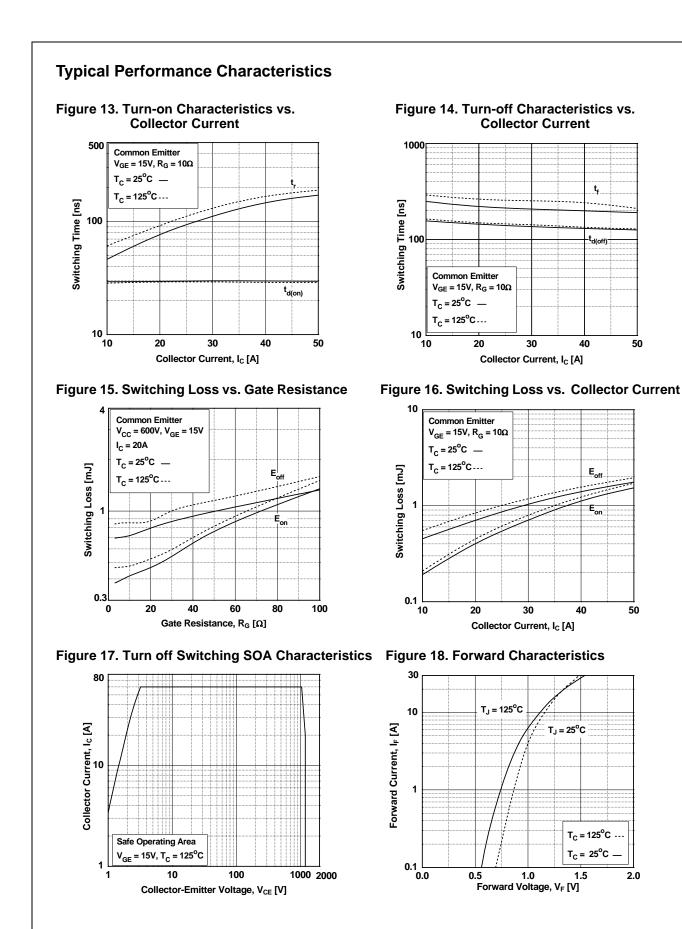
Figure 10. SOA Characteristics

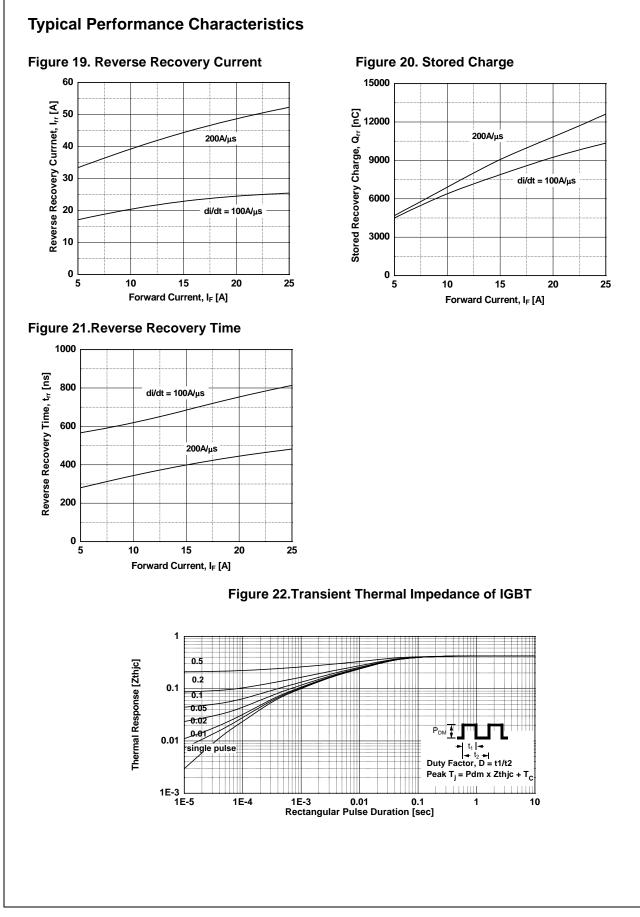




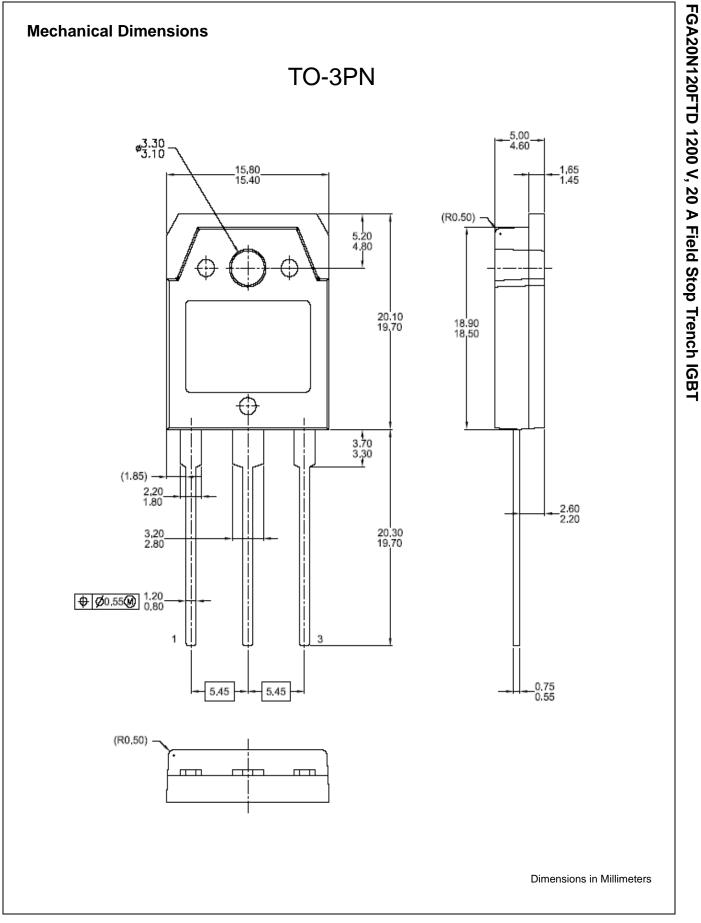


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